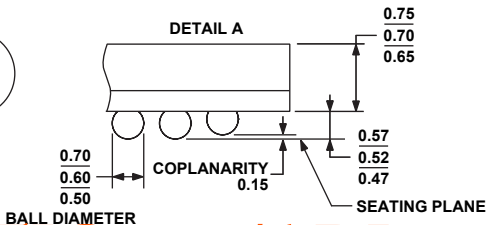
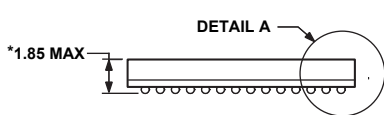
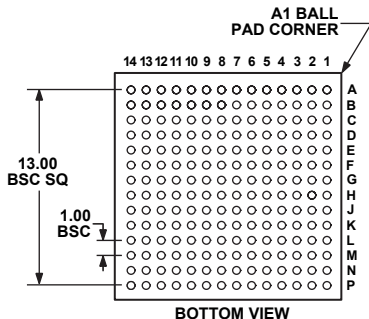
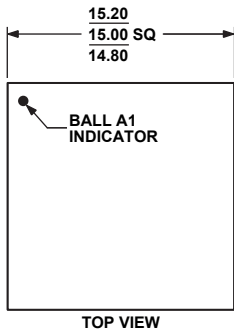


**196-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-196-2)**

Dimensions shown in millimeters



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*COPLANARITY TO JEDEC STANDARD MS-013, TABLE 1
WITH THE EXCEPTION TO PACKAGE HEIGHT.